Lattice Semiconductor Corporation - LFSC3GA40E-6FFA1020I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	562
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1020-BBGA, FCBGA
Supplier Device Package	1020-OFcBGA Rev 2 (33x33)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga40e-6ffa1020i

PCI Specification, Revision 2.2 requires the use of clamping diodes for 3.3V operation. For more information on the PCI interface, please refer to the PCI Specification, Revision 2.2.

Programmable Slew Rate Control

All output and bidirectional buffers have an optional programmable output slew rate control that can be configured for either low noise or high-speed performance. Each I/O pin has an individual slew rate control. This allows designers to specify slew rate control on a pin-by-pin basis. This slew rate control affects both the rising and falling edges.

Programmable Termination

Many of the I/O standards supported by the LatticeSC devices require termination at the transmitter, receiver or both. The SC devices provide the capability to implement many kinds of termination on-chip, minimizing stub lengths and hence improving performance. Utilizing this feature also has the benefit of reducing the number of discrete components required on the circuit board. The termination schemes can be split into two categories single-ended and differential.

Single Ended Termination

Single Ended Outputs: The SC devices support a number of different terminations for single ended outputs:

- Series
- Parallel to V_{CCIO} or GND
- Parallel to $V_{CCIO}/2$
- Parallel to $V_{CCIO}/2$ combined with series

Figure 2-27 shows the single ended output schemes that are supported. The nominal values of the termination resistors are shown in Table 2-10.

this allows for easy integration with the rest of the system. These capabilities make the LatticeSC ideal for many multiple power supply and hot-swap applications. The maximum current during hot socketing is 4mA. See Hot Socketing Specifications in Chapter 3 of this data sheet.

Power-Up Requirements

To prevent high power supply and input pin currents, each VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies must have a monotonic ramp up time of 75 ms or less to reach its minimum operating voltage. Apart from VCC and VCC12, which have an additional requirement, and VCCIO and VCCAUX, which also have an additional requirement, the VCC, VCC12, VCCAUX, VCCIO and VCCJ power supplies can ramp up in any order, with no restriction on the time between them. However, the ramp time for each must be 75 ms or less. Configuration of the device will not proceed until the last power supply has reached its minimum operating voltage.

Additional Requirement for VCC and VCC12:
VCC12 must always be higher than VCC. This condition must be maintained at ALL times, including during power-up and power-down. Note that for 1.2V only operation, it is advisable to source both of these supplies from the same power supply.

Additional Requirement for VCCIO and VCCAUX:
If any VCCIOs are 1.2/1.5/1.8V, then VCCAUX MUST be applied before them. If any VCCIO is 1.2/1.5/1.8V and is powered up before VCCAUX, then when VCCAUX is powered up, it may drag VCCIO up with it as it crosses through the VCCIO value. (Note: If the VCCIO supply is capable of sinking current, as well as the more usual sourcing capability, this behavior is eliminated. However, the amount of current that the supply needs to sink is unknown and is likely to be in the hundreds of milliamps range).

Power-Down Requirements

To prevent high power supply and input pin currents, power must be removed monotonically from either VCC or VCCAUX (and must reach the power-down trip point of 0.5V for VCC, 0.95V for VCCAUX) before power is removed monotonically from VCC12, any of the VCCIOs, or VCCJ. Note that VCC12 can be removed at the same time as VCC, but it cannot be removed earlier. In many applications, VCC and VCC12 will be sourced from the same power supply and so will be removed together. For systems where disturbance of the user pins is a don't care condition, the power supplies can be removed in any order as long as they power down monotonically within 200ms of each other.

Additionally, if any banks have VCCIO=3.3V nominal (potentially banks 1, 4, 5) then VCCIO for those banks must not be lower than VCCAUX during power-down. The normal variation in ramp-up times of power supplies and voltage regulators is not a concern here.

Note: The SERDES power supplies are NOT included in these requirements and have no specific sequencing requirements. However, when using the SERDES with VDDIB or VDDOB that is greater than 1.2V (1.5V nominal for example), the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in the ramp-up times of power supplies and voltage regulators is not a concern here.

SERDES Power Supply Sequencing Requirements

When using the SERDES with 1.5V VDDIB or VDDOB supplies, the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and the 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in ramp-up times of power supples and voltage regulators is not a concern.

Additional Requirement for SERDES Power Supply
All VCC12 pins need to be connected on all devices independent of functionality used on the device. This analog supply is used by both the RX and TX portions of the SERDES and is used to control the core SERDES logic regardless of the SERDES being used in the design. VDDIB and VDDOB are used as supplies for the terminations on the CML input and output buffers. If a particular channel is not used, these can be UNCONNECTED (floating).

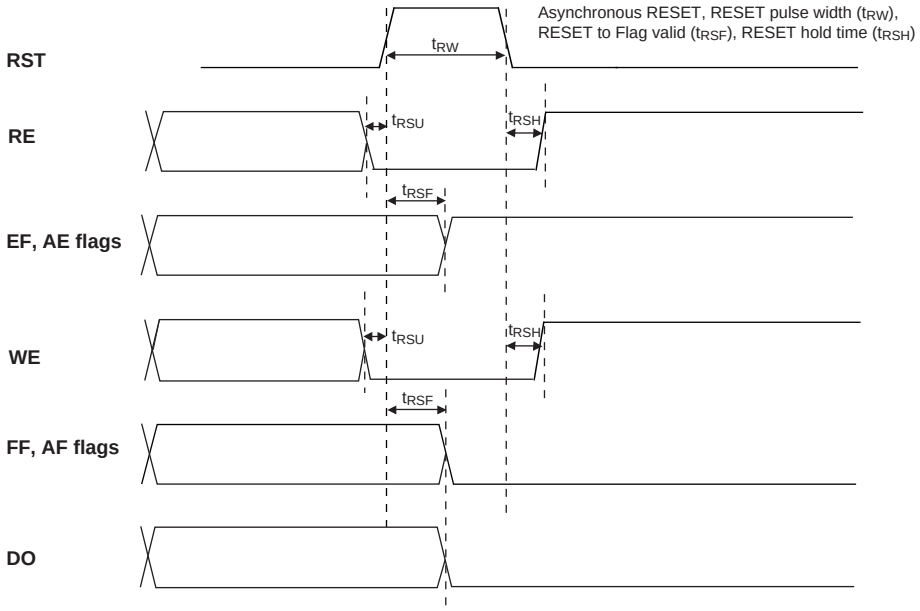
RSDS

Over Recommended Operating Conditions

Parameter Symbol	Description	Min.	Typ.	Max.	Units
V_{OD}	Output voltage, differential, R_T = 100 ohms	100	200	600	mV
V_{OS}	Output voltage, common mode	0.5	1.2	1.5	V
I_{RSDS}	Differential driver output current	1	2	6	mA
V_{THD}	Input voltage differential	100	—	—	mV
V_{CM}	Input common mode voltage	0.3	—	1.5	V
T_R, T_F	Output rise and fall times, 20% to 80%	—	500	—	ps
T_{ODUTY}	Output clock duty cycle	45	50	55	%

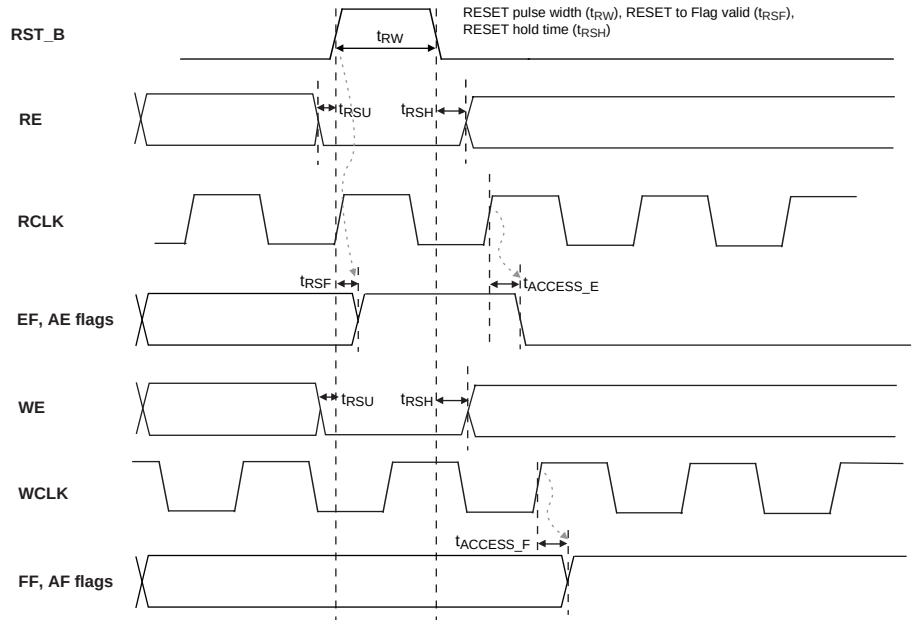
Note: Data is for 2mA drive. Other differential driver current options are available.

Figure 3-10. FIFO Reset Waveform



Note: RE and WE must be deactivated t_{RSU} before the Positive FIFO reset edge and enabled t_{RSH} after the FIFO reset negative edge.

Figure 3-11. Read Pointer Reset Waveform



Note: RE and WE must be deactivated t_{RSU} before the Positive FIFO reset edge and enabled t_{RSH} after the FIFO reset negative edge.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
MPI_STRBN	I	Driven active low indicates the start of a transaction on the PowerPC bus. MPI will strobe the address bus at next rising edge of clock.
MPI_ADDR[31:14]	I	Address bus driven by a PowerPC bus master. Only 18-bit width is needed. It has to be the least significant bit of the PowerPC 32-bit address A[31:14].
MPI_DAT[n:0]	I/O	Selectable data bus width from 8, and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
MPI_PAR[m:0]	I/O	Selectable parity bus width from 1, 2, and 3-bit. MPI_DP[0] for MPI_D[7:0], MPI_DP[1] for MPI_D[15:8] and MPI_DP[2] for MPI_D[23:16].
MPI_TA	O	Transfer acknowledge. Driven active low indicates that MPI received the data on the write cycle or returned data on the read cycle.
MPI_TEA	O	Transfer Error Acknowledge. Driven active low indicates that MPI detects a bus error on the internal system bus for current transaction.
MPI_RETRY	O	Active low MPI Retry requests the MPC860 to relinquish the bus and retry the cycle.
Multi-chip Alignment (User I/O if not used.)		
MCA_DONE_OUT	O	Multi-chip alignment done output (to second MCA chip)
MCA_DONE_IN	I	Multi-chip alignment done input (from second MCA chip)
MCA_CLK_P[1:2]_OUT	O	Multi-chip alignment clock [1:2] output (sourced by MCA master chip)
MCA_CLK_P[1:2]_IN	I	Multi-chip alignment clock [1:2] input (from MCA master chip
TEMP	—	Temperature sensing diode pin. Dedicated pin. Accuracy is typically +/- 10°C.
Miscellaneous Dedicated Pins		
XRES	—	External reference resistor between this pin and ground. The reference resistor is used to calibrate the programmable terminating resistors used in the I/Os. Dedicated pin. Value: 1K ± 1% ohm.
DIFFRx	—	Only used if a differential driver is used in a bank. This DIFFRx must be connected to ground via an external 1K ±1% ohm resistor for all banks that have a differential driver.
SERDES Block (Dedicated Pins)		
[A:D]_HDINPx_[L/R]	I	High-speed input (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDINNx_[L/R]	I	High-speed input (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTPx_[L/R]	O	High-speed output (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTNx_[L/R]	O	High-speed output (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_REFCLKP_[L/R]	I	Ref clock input (positive), aux channel on left [L] or right [R] side of device.
[A:D]_REFCLKN_[L/R]	I	Ref clock input (negative), aux channel on left [L] or right [R] side of device.

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
N12	PB39C	4	
T15	PB40A	4	PCLKT4_3
R16	PB40B	4	PCLKC4_3
L12	PB43A	4	
M12	PB43B	4	
P16	PB44A	4	
N16	PB44B	4	
R14	PB47C	4	VREF1_4
P15	PB48A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
M13	PB48B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
N13	PB49A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
P14	PB49B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
M16	PR45B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
L16	PR45A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
M14	PR43B	3	
M15	PR43A	3	
K16	PR41D	3	VREF2_3
J16	PR37B	3	
H16	PR37A	3	
L13	PR35D	3	DIFFR_3
L14	PR35B	3	
L15	PR35A	3	
K12	PR31C	3	VREF1_3
J13	PR28D	3	PCLKC3_2
K13	PR28C	3	PCLKT3_2
H15	PR28B	3	
F16	PR28A	3	
J11	PR26D	3	PCLKC3_1
J12	PR26C	3	PCLKT3_1
J15	PR26B	3	PCLKC3_0
J14	PR26A	3	PCLKT3_0
E16	PR24D	2	PCLKC2_2
D16	PR24C	2	PCLKT2_2
H11	PR24B	2	PCLKC2_0
H12	PR24A	2	PCLKT2_0
H13	PR23B	2	PCLKC2_1
H14	PR23A	2	PCLKT2_1
G12	PR22D	2	DIFFR_2
G13	PR22C	2	VREF1_2
F8	PR22B	2	
F9	PR22A	2	
G16	PR18D	2	VREF2_2
F15	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P22	VCCIO2	-		VCCIO2	-	
R22	VCCIO2	-		VCCIO2	-	
AA23	VCCIO3	-		VCCIO3	-	
AA24	VCCIO3	-		VCCIO3	-	
AB23	VCCIO3	-		VCCIO3	-	
AB24	VCCIO3	-		VCCIO3	-	
T22	VCCIO3	-		VCCIO3	-	
U22	VCCIO3	-		VCCIO3	-	
V22	VCCIO3	-		VCCIO3	-	
W22	VCCIO3	-		VCCIO3	-	
Y22	VCCIO3	-		VCCIO3	-	
Y23	VCCIO3	-		VCCIO3	-	
Y24	VCCIO3	-		VCCIO3	-	
AB16	VCCIO4	-		VCCIO4	-	
AB17	VCCIO4	-		VCCIO4	-	
AB18	VCCIO4	-		VCCIO4	-	
AB19	VCCIO4	-		VCCIO4	-	
AB20	VCCIO4	-		VCCIO4	-	
AC20	VCCIO4	-		VCCIO4	-	
AC21	VCCIO4	-		VCCIO4	-	
AC22	VCCIO4	-		VCCIO4	-	
AD20	VCCIO4	-		VCCIO4	-	
AD21	VCCIO4	-		VCCIO4	-	
AD22	VCCIO4	-		VCCIO4	-	
AB11	VCCIO5	-		VCCIO5	-	
AB12	VCCIO5	-		VCCIO5	-	
AB13	VCCIO5	-		VCCIO5	-	
AB14	VCCIO5	-		VCCIO5	-	
AB15	VCCIO5	-		VCCIO5	-	
AC10	VCCIO5	-		VCCIO5	-	
AC11	VCCIO5	-		VCCIO5	-	
AC9	VCCIO5	-		VCCIO5	-	
AD10	VCCIO5	-		VCCIO5	-	
AD11	VCCIO5	-		VCCIO5	-	
AD9	VCCIO5	-		VCCIO5	-	
AA7	VCCIO6	-		VCCIO6	-	
AA8	VCCIO6	-		VCCIO6	-	
AB7	VCCIO6	-		VCCIO6	-	
AB8	VCCIO6	-		VCCIO6	-	
T9	VCCIO6	-		VCCIO6	-	
U9	VCCIO6	-		VCCIO6	-	
V9	VCCIO6	-		VCCIO6	-	
W9	VCCIO6	-		VCCIO6	-	
Y7	VCCIO6	-		VCCIO6	-	
Y8	VCCIO6	-		VCCIO6	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B1	GND	-		GND	-	
B32	GND	-		GND	-	
C11	GND	-		GND	-	
C12	GND	-		GND	-	
C16	GND	-		GND	-	
C21	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C25	GND	-		GND	-	
C26	GND	-		GND	-	
C27	GND	-		GND	-	
C29	GND	-		GND	-	
C3	GND	-		GND	-	
C30	GND	-		GND	-	
C4	GND	-		GND	-	
C6	GND	-		GND	-	
C7	GND	-		GND	-	
C8	GND	-		GND	-	
C9	GND	-		GND	-	
D17	GND	-		GND	-	
F18	GND	-		GND	-	
F3	GND	-		GND	-	
F30	GND	-		GND	-	
F9	GND	-		GND	-	
G15	GND	-		GND	-	
G24	GND	-		GND	-	
G29	GND	-		GND	-	
G3	GND	-		GND	-	
J14	GND	-		GND	-	
J22	GND	-		GND	-	
J26	GND	-		GND	-	
J6	GND	-		GND	-	
K11	GND	-		GND	-	
K19	GND	-		GND	-	
K30	GND	-		GND	-	
K4	GND	-		GND	-	
L23	GND	-		GND	-	
L9	GND	-		GND	-	
M13	GND	-		GND	-	
M15	GND	-		GND	-	
M18	GND	-		GND	-	
M20	GND	-		GND	-	
M27	GND	-		GND	-	
M7	GND	-		GND	-	
N12	GND	-		GND	-	
N14	GND	-		GND	-	
N19	GND	-		GND	-	
N21	GND	-		GND	-	
N29	GND	-		GND	-	
N3	GND	-		GND	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH11	PB57D	4		PB79D	4	
AN13	PB58A	4	PCLKT4_3	PB80A	4	PCLKT4_3
AN12	PB58B	4	PCLKC4_3	PB80B	4	PCLKC4_3
AD14	PB58C	4	PCLKT4_4	PB80C	4	PCLKT4_4
AD15	PB58D	4	PCLKC4_4	PB80D	4	PCLKC4_4
AP13	PB61A	4		PB73A	4	
AP12	PB61B	4		PB73B	4	
AK13	PB61C	4		PB73C	4	
AK12	PB61D	4		PB73D	4	
AP11	PB62A	4		PB83A	4	
AP10	PB62B	4		PB83B	4	
AN11	PB63A	4		PB99A	4	
AN10	PB63B	4		PB99B	4	
AF14	PB63C	4		PB99C	4	
AF13	PB63D	4		PB99D	4	
AM10	PB67A	4		PB101A	4	
AM9	PB67B	4		PB101B	4	
AE14	PB67C	4		PB101C	4	
AE13	PB67D	4		PB101D	4	
AP9	PB69A	4		PB104A	4	
AP8	PB69B	4		PB104B	4	
AK11	PB69C	4		PB104C	4	
AK10	PB69D	4		PB104D	4	
AL10	PB70A	4		PB107A	4	
AL9	PB70B	4		PB107B	4	
AF12	PB70C	4		PB107C	4	
AF11	PB70D	4		PB107D	4	
AN9	PB73A	4		PB109A	4	
AN8	PB73B	4		PB109B	4	
AG11	PB73C	4		PB109C	4	
AG10	PB73D	4		PB109D	4	
AP7	PB74A	4		PB111A	4	
AP6	PB74B	4		PB111B	4	
AG13	PB74C	4		PB111C	4	
AG12	PB74D	4		PB111D	4	
AN7	PB75A	4		PB113A	4	
AN6	PB75B	4		PB113B	4	
AK9	PB75C	4		PB113C	4	
AK8	PB75D	4		PB113D	4	
AP5	PB77A	4		PB115A	4	
AP4	PB77B	4		PB115B	4	
AD11	PB77C	4		PB115C	4	
AE11	PB77D	4		PB115D	4	
AM7	PB78A	4		PB117A	4	
AM6	PB78B	4		PB117B	4	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y4	PR48B	3		PR63B	3	
W4	PR48A	3		PR63A	3	
W11	PR47D	3		PR60D	3	
V11	PR47C	3		PR60C	3	
W2	PR47B	3		PR60B	3	
V2	PR47A	3		PR60A	3	
W9	PR45D	3		PR57D	3	
V9	PR45C	3		PR57C	3	
V1	PR45B	3		PR57B	3	
U1	PR45A	3		PR57A	3	
W10	PR44D	3		PR56D	3	
V10	PR44C	3		PR56C	3	
U2	PR44B	3		PR56B	3	
T2	PR44A	3		PR56A	3	
Y8	PR43D	3		PR55D	3	
W8	PR43C	3	VREF1_3	PR55C	3	VREF1_3
W5	PR43B	3		PR55B	3	
V5	PR43A	3		PR55A	3	
V7	PR40D	3	PCLKC3_2	PR52D	3	PCLKC3_2
U7	PR40C	3	PCLKT3_2	PR52C	3	PCLKT3_2
T1	PR40B	3		PR52B	3	
R1	PR40A	3		PR52A	3	
V8	PR39D	3	PCLKC3_3	PR51D	3	PCLKC3_3
U8	PR39C	3	PCLKT3_3	PR51C	3	PCLKT3_3
U5	PR39B	3		PR51B	3	
T5	PR39A	3		PR51A	3	
V6	PR38D	3	PCLKC3_1	PR50D	3	PCLKC3_1
U6	PR38C	3	PCLKT3_1	PR50C	3	PCLKT3_1
T4	PR38B	3	PCLKC3_0	PR50B	3	PCLKC3_0
T3	PR38A	3	PCLKT3_0	PR50A	3	PCLKT3_0
U9	PR36D	2	PCLKC2_2	PR48D	2	PCLKC2_2
T9	PR36C	2	PCLKT2_2	PR48C	2	PCLKT2_2
R2	PR36B	2	PCLKC2_0	PR48B	2	PCLKC2_0
P2	PR36A	2	PCLKT2_0	PR48A	2	PCLKT2_0
T11	PR35D	2	PCLKC2_3	PR47D	2	PCLKC2_3
U11	PR35C	2	PCLKT2_3	PR47C	2	PCLKT2_3
R4	PR35B	2	PCLKC2_1	PR47B	2	PCLKC2_1
R3	PR35A	2	PCLKT2_1	PR47A	2	PCLKT2_1
T8	PR34D	2		PR46D	2	
R8	PR34C	2		PR46C	2	
P1	PR34B	2		PR46B	2	
N1	PR34A	2		PR46A	2	
R6	PR31D	2		PR43D	2	
P6	PR31C	2		PR43C	2	
M1	PR31B	2		PR43B	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
F6	A_VDDOB0_R	-	
B4	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
F7	A_VDDOB1_R	-	
B5	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
E6	VCC12	-	
A5	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
B6	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
A6	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
C6	VCC12	-	
D4	A_VDDIB1_R	-	
C7	VCC12	-	
D5	A_VDDIB2_R	-	
A7	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
B7	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
E7	VCC12	-	
A8	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
F8	A_VDDOB2_R	-	
B8	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
F9	A_VDDOB3_R	-	
B9	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
E8	VCC12	-	
A9	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
B10	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
A10	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
C10	VCC12	-	
D6	A_VDDIB3_R	-	
G10	VCC12	-	
D7	B_VDDIB0_R	-	
E10	B_HDINP0_R	-	PCS 3E1 CH 0 IN P
F10	B_HDINN0_R	-	PCS 3E1 CH 0 IN N
K10	VCC12	-	
A11	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P
D10	B_VDDOB0_R	-	
B11	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N
D11	B_VDDOB1_R	-	
B12	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N
L10	VCC12	-	
A12	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P
F11	B_HDINN1_R	-	PCS 3E1 CH 1 IN N
E11	B_HDINP1_R	-	PCS 3E1 CH 1 IN P
G11	VCC12	-	
D8	B_VDDIB1_R	-	
G12	VCC12	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
H34	PL40B	7	
M32	PL53A	7	
N32	PL53B	7	
P28	PL53C	7	
R28	PL53D	7	
J34	PL55A	7	
K34	PL55B	7	
P30	PL55C	7	
R30	PL55D	7	
W34	PL73A	6	
Y34	PL73B	6	
W32	PL75A	6	
Y32	PL75B	6	
AA34	PL78A	6	
AB34	PL78B	6	
AC34	PL81A	6	
AD34	PL81B	6	
Y30	PL82A	6	
AA30	PL82B	6	
AB33	PL83A	6	
AC33	PL83B	6	
AC2	PR83B	3	
AB2	PR83A	3	
AA5	PR82B	3	
Y5	PR82A	3	
AD1	PR81B	3	
AC1	PR81A	3	
AB1	PR78B	3	
AA1	PR78A	3	
Y3	PR75B	3	
W3	PR75A	3	
Y1	PR73B	3	
W1	PR73A	3	
R5	PR55D	2	
P5	PR55C	2	
K1	PR55B	2	
J1	PR55A	2	
R7	PR53D	2	
P7	PR53C	2	
N3	PR53B	2	
M3	PR53A	2	
H1	PR40B	2	
G1	PR40A	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AL5	GND	-	
AM14	GND	-	
AM18	GND	-	
AM24	GND	-	
AM30	GND	-	
AM8	GND	-	
AN1	GND	-	
AN34	GND	-	
AP2	GND	-	
AP33	GND	-	
B1	GND	-	
B34	GND	-	
C11	GND	-	
C12	GND	-	
C13	GND	-	
C14	GND	-	
C17	GND	-	
C21	GND	-	
C22	GND	-	
C23	GND	-	
C24	GND	-	
C26	GND	-	
C27	GND	-	
C30	GND	-	
C31	GND	-	
C4	GND	-	
C5	GND	-	
C8	GND	-	
C9	GND	-	
D18	GND	-	
E32	GND	-	
E4	GND	-	
F19	GND	-	
G16	GND	-	
G29	GND	-	
G7	GND	-	
H3	GND	-	
H31	GND	-	
J10	GND	-	
J15	GND	-	
J26	GND	-	
K20	GND	-	
K23	GND	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
U22	VCCAUX	-	
V13	VCCAUX	-	
V22	VCCAUX	-	
V23	VCCAUX	-	
W13	VCCAUX	-	
W22	VCCAUX	-	
Y21	GND	-	
Y25	GND	-	
C18	VCCIO1	-	
D17	VCCIO1	-	
F16	VCCIO1	-	
G19	VCCIO1	-	
J20	VCCIO1	-	
K12	VCCIO1	-	
K15	VCCIO1	-	
L23	VCCIO1	-	
Y9	GND	-	
J9	VCCIO1	-	
E3	VCCIO2	-	
G6	VCCIO2	-	
H4	VCCIO2	-	
K7	VCCIO2	-	
L3	VCCIO2	-	
M11	VCCIO2	-	
N6	VCCIO2	-	
P4	VCCIO2	-	
R9	VCCIO2	-	
AA3	VCCIO3	-	
AB7	VCCIO3	-	
AC10	VCCIO3	-	
AD4	VCCIO3	-	
AE6	VCCIO3	-	
AG3	VCCIO3	-	
AK4	VCCIO3	-	
T7	VCCIO3	-	
U3	VCCIO3	-	
V4	VCCIO3	-	
W6	VCCIO3	-	
Y10	VCCIO3	-	
AD12	VCCIO4	-	
AF15	VCCIO4	-	
AF9	VCCIO4	-	
AH10	VCCIO4	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AU9	PB103C	4		PB117C	4	
AU8	PB103D	4		PB117D	4	
AY8	PB104A	4		PB118A	4	
AY7	PB104B	4		PB118B	4	
AU7	PB104C	4		PB118C	4	
AU6	PB104D	4		PB118D	4	
BA7	PB105A	4		PB119A	4	
BA6	PB105B	4		PB119B	4	
AN13	PB105C	4		PB119C	4	
AN12	PB105D	4		PB119D	4	
AV9	PB107A	4		PB121A	4	
AV8	PB107B	4		PB121B	4	
AT10	PB107C	4		PB121C	4	
AT9	PB107D	4		PB121D	4	
AW8	PB108A	4		PB122A	4	
AW7	PB108B	4		PB122B	4	
AP11	PB108C	4		PB122C	4	
AP10	PB108D	4		PB122D	4	
BB5	PB109A	4		PB123A	4	
BB4	PB109B	4		PB123B	4	
AR10	PB109C	4		PB123C	4	
AR9	PB109D	4		PB123D	4	
BA5	PB111A	4		PB125A	4	
BA4	PB111B	4		PB125B	4	
AT7	PB111C	4		PB125C	4	
AT6	PB111D	4		PB125D	4	
BB3	PB112A	4		PB126A	4	
BA3	PB112B	4		PB126B	4	
AM14	PB112C	4		PB126C	4	
AL14	PB112D	4		PB126D	4	
AY5	PB113A	4		PB127A	4	
AY4	PB113B	4		PB127B	4	
AN11	PB113C	4		PB127C	4	
AN10	PB113D	4		PB127D	4	
AV7	PB115A	4		PB129A	4	
AV6	PB115B	4		PB129B	4	
AM12	PB115C	4		PB129C	4	
AM11	PB115D	4		PB129D	4	
AW5	PB116A	4		PB130A	4	
AW4	PB116B	4		PB130B	4	
AT5	PB116C	4		PB130C	4	
AT4	PB116D	4		PB130D	4	
AY2	PB117A	4		PB131A	4	
BA2	PB117B	4		PB131B	4	
AP9	PB117C	4		PB131C	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
A26	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N
C34	D_VDDOB2_L	-		D_VDDOB2_L	-	
B26	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P
C32	VCC12	-		VCC12	-	
E27	D_HDINN2_L	-	PCS 363 CH 2 IN N	D_HDINN2_L	-	PCS 363 CH 2 IN N
D27	D_HDINP2_L	-	PCS 363 CH 2 IN P	D_HDINP2_L	-	PCS 363 CH 2 IN P
G25	D_VDDIB2_L	-		D_VDDIB2_L	-	
F29	VCC12	-		VCC12	-	
H26	D_VDDIB1_L	-		D_VDDIB1_L	-	
F30	VCC12	-		VCC12	-	
D28	D_HDINP1_L	-	PCS 363 CH 1 IN P	D_HDINP1_L	-	PCS 363 CH 1 IN P
E28	D_HDINN1_L	-	PCS 363 CH 1 IN N	D_HDINN1_L	-	PCS 363 CH 1 IN N
B27	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P
F36	VCC12	-		VCC12	-	
A27	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N
F35	D_VDDOB1_L	-		D_VDDOB1_L	-	
A28	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N
M30	D_VDDOB0_L	-		D_VDDOB0_L	-	
B28	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P
F37	VCC12	-		VCC12	-	
E29	D_HDINN0_L	-	PCS 363 CH 0 IN N	D_HDINN0_L	-	PCS 363 CH 0 IN N
D29	D_HDINP0_L	-	PCS 363 CH 0 IN P	D_HDINP0_L	-	PCS 363 CH 0 IN P
H27	D_VDDIB0_L	-		D_VDDIB0_L	-	
G28	VCC12	-		VCC12	-	
J28	C_REFCLKP_L	-		C_REFCLKP_L	-	
K28	C_REFCLKN_L	-		C_REFCLKN_L	-	
F32	VCC12	-		VCC12	-	
G29	C_VDDIB3_L	-		C_VDDIB3_L	-	
C31	VCC12	-		VCC12	-	
D30	C_HDINP3_L	-	PCS 362 CH 3 IN P	C_HDINP3_L	-	PCS 362 CH 3 IN P
E30	C_HDINN3_L	-	PCS 362 CH 3 IN N	C_HDINN3_L	-	PCS 362 CH 3 IN N
B29	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P
F38	VCC12	-		VCC12	-	
A29	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N
J33	C_VDDOB3_L	-		C_VDDOB3_L	-	
A30	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N
K33	C_VDDOB2_L	-		C_VDDOB2_L	-	
B30	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P
J34	VCC12	-		VCC12	-	
F31	C_HDINN2_L	-	PCS 362 CH 2 IN N	C_HDINN2_L	-	PCS 362 CH 2 IN N
E31	C_HDINP2_L	-	PCS 362 CH 2 IN P	C_HDINP2_L	-	PCS 362 CH 2 IN P
G30	C_VDDIB2_L	-		C_VDDIB2_L	-	
H28	VCC12	-		VCC12	-	
C37	C_VDDIB1_L	-		C_VDDIB1_L	-	
H30	VCC12	-		VCC12	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
T16	GND	-		GND	-	
T19	GND	-		GND	-	
T24	GND	-		GND	-	
T27	GND	-		GND	-	
T32	GND	-		GND	-	
U18	GND	-		GND	-	
U20	GND	-		GND	-	
U23	GND	-		GND	-	
U25	GND	-		GND	-	
U36	GND	-		GND	-	
U7	GND	-		GND	-	
G36	GND	-		GND	-	
G7	GND	-		GND	-	
V17	GND	-		GND	-	
V19	GND	-		GND	-	
V24	GND	-		GND	-	
V26	GND	-		GND	-	
V4	GND	-		GND	-	
V40	GND	-		GND	-	
W12	GND	-		GND	-	
W16	GND	-		GND	-	
W18	GND	-		GND	-	
W20	GND	-		GND	-	
W23	GND	-		GND	-	
W25	GND	-		GND	-	
W27	GND	-		GND	-	
W31	GND	-		GND	-	
Y17	GND	-		GND	-	
Y19	GND	-		GND	-	
Y21	GND	-		GND	-	
Y22	GND	-		GND	-	
AA17	VCC	-		VCC	-	
AA18	VCC	-		VCC	-	
AA19	VCC	-		VCC	-	
AA21	VCC	-		VCC	-	
AA22	VCC	-		VCC	-	
AA24	VCC	-		VCC	-	
AA25	VCC	-		VCC	-	
AA26	VCC	-		VCC	-	
AB17	VCC	-		VCC	-	
AB18	VCC	-		VCC	-	
AB19	VCC	-		VCC	-	
AB21	VCC	-		VCC	-	
AB22	VCC	-		VCC	-	
AB24	VCC	-		VCC	-	

Conventional Packaging

Commercial

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-7F256C	-7	fpBGA	256	COM	15.2
LFSC3GA15E-6F256C	-6	fpBGA	256	COM	15.2
LFSC3GA15E-5F256C	-5	fpBGA	256	COM	15.2
LFSC3GA15E-7F900C	-7	fpBGA	900	COM	15.2
LFSC3GA15E-6F900C	-6	fpBGA	900	COM	15.2
LFSC3GA15E-5F900C	-5	fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-7F256C	-7	fpBGA	256	COM	15.2
LFSCM3GA15EP1-6F256C	-6	fpBGA	256	COM	15.2
LFSCM3GA15EP1-5F256C	-5	fpBGA	256	COM	15.2
LFSCM3GA15EP1-7F900C	-7	fpBGA	900	COM	15.2
LFSCM3GA15EP1-6F900C	-6	fpBGA	900	COM	15.2
LFSCM3GA15EP1-5F900C	-5	fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-7F900C	-7	fpBGA	900	COM	25.4
LFSC3GA25E-6F900C	-6	fpBGA	900	COM	25.4
LFSC3GA25E-5F900C	-5	fpBGA	900	COM	25.4
LFSC3GA25E-7FF1020C[1]	-7	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-6FF1020C[1]	-6	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-5FF1020C[1]	-5	Organic fcBGA	1020	COM	25.4
LFSC3GA25E-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-7F900C	-7	fpBGA	900	COM	25.4
LFSCM3GA25EP1-6F900C	-6	fpBGA	900	COM	25.4
LFSCM3GA25EP1-5F900C	-5	fpBGA	900	COM	25.4
LFSCM3GA25EP1-7FF1020C[1]	-7	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-6FF1020C[1]	-6	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-5FF1020C[1]	-5	Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Industrial

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-6FN256I	-6	Lead-Free fpBGA	256	IND	15.2
LFSC3GA15E-5FN256I	-5	Lead-Free fpBGA	256	IND	15.2
LFSC3GA15E-6FN900I	-6	Lead-Free fpBGA	900	IND	15.2
LFSC3GA15E-5FN900I	-5	Lead-Free fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-6FN256I	-6	Lead-Free fpBGA	256	IND	15.2
LFSCM3GA15EP1-5FN256I	-5	Lead-Free fpBGA	256	IND	15.2
LFSCM3GA15EP1-6FN900I	-6	Lead-Free fpBGA	900	IND	15.2
LFSCM3GA15EP1-5FN900I	-5	Lead-Free fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-6FN900I	-6	Lead-Free fpBGA	900	IND	25.4
LFSC3GA25E-5FN900I	-5	Lead-Free fpBGA	900	IND	25.4
LFSC3GA25E-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	25.4
LFSC3GA25E-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	25.4
LFSC3GA25E-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4
LFSC3GA25E-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-6FN900I	-6	Lead-Free fpBGA	900	IND	25.4
LFSCM3GA25EP1-5FN900I	-5	Lead-Free fpBGA	900	IND	25.4
LFSCM3GA25EP1-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4
LFSCM3GA25EP1-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	40.4
LFSC3GA40E-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	40.4
LFSC3GA40E-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-6FCN1152I[2]	-6	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-5FCN1152I[2]	-5	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	40.4
LFSC3GA40E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

LatticeSC/M Family Data Sheet Revision History

December 2011 **Data Sheet DS1004**

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
March 2006	01.1	Introduction	SC25 1020 I/O count changed to 476.
		Architecture	Changed ROM 16X4 to ROM 16X2.
			Changed “X2 or X4” to “DIV2 or DIV4”.
			Added Global Set/Reset Section.
		DC and Switching Characteristics	Added notes 5 and 6 to Recommended Operating Conditions table.
			Added Power Supply Ramp Rates table.
			Removed -5 and -6 speed grades from Typical Building Block Performance table.
			Added Input Delay Timing table.
			Added Synchronous GSR Timing table.
		Pinout Information	Expanded PROBE_VCC and PROBE_GND description.
			Removed A-RXREFCLKP_[L/R] from Signal Description table.
			Added RESP_[ULC/URC] to Signal Description table.
			Added notes 1 and 2 to Signal Description table.
			Changed number of NCs to 28.
			Changed number of SERDES (signal + power supply) to 74.
			Removed RESP balls from NC list (B2, C2, B29, C29).
			Added note to VTT table.
			Changed RxRefclk (B2 and C2) to NC.
			Added RESP_ULC.
			Added RESP_URC.
			Changed RxRefclk (B29 and C29) to NC.
June 2006	01.2	Introduction	Changed SERDES min bandwidth from 622 Mbps to 600 Mbps.
			Changed max SERDES bandwidth from 3.4 Gbps to 3.8 Gbps.
			Corrected number of package I/Os for the SC80 and SC115 1704 pin packages.
			Updated speed performance for typical functions with ispLEVER 6.0 values.
		Architecture	Changed “When these pins are not used they should be left unconnected.” with “Unused VTT pins should be connected to GND if the internal or external VCMT function is not used in the bank. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.”
			Added “SERDES Power Supply Sequencing Requirements” section.
			Changed total bandwidth per quad from 13.6 Gbps to 15.2 Gbps.
			Added the accuracy of the temperature-sensing diode to be typically +/- 10 °C. Also referred to a temperature-sensing diode application note for more information.
		DC and Switching Characteristics	Changed “CTAP” to “internal or external VCMT”.
			Changed VCC12 parameter to include VDDP, VDDTX and VDDRX.
			Changed typical values to match ispLEVER 6.0 Power Calculator.